



Product Change Notification

Change Notification #: 116850 - 00
Change Title: Intel® Dual Band Wireless-AC 3165 and Intel® Dual Band Wireless-AC 7265
SKUs: 7265.D2WG.I; 3165.D2WG;
 3165.D2WG.S; 3165.D2WG18V;
 7265.D2WG.W; 7265.D2WG.S;
 7265.D2WG18V; 7265.D2WG18V.S;
 7265.D2WG18V.S1; 7265.D2WG.NVB
PCN 116850-00, Label, Update Japan Regulatory Marking
Date of Publication: March 21, 2019

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	April 12, 2019
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Description of Change to the Customer:

The Intel® Wireless-AC3165/7265 1216 SKUs listed in the products affected table below will undergo the following changes:

1. Update Japan Regulatory marking per below:

StP2 1216: 7265D2W

RF: 003-140134
TEL: D140087003

5.2GHz帯高出力データ通信システム基地局又は陸上移動中継局と通信する場合を除く



R 003-140134

5.15-5.35GHz: Indoor use only
(Except communicate to high power radio)

T D140087003

StP1 1216: 3165D2W

RF: 003-150155
TEL: D150112003

5.2GHz帯高出力データ通信システム基地局又は陸上移動中継局と通信する場合を除く



R 003-150155

5.15-5.35GHz: Indoor use only
(Except communicate to high power radio)

T D150112003

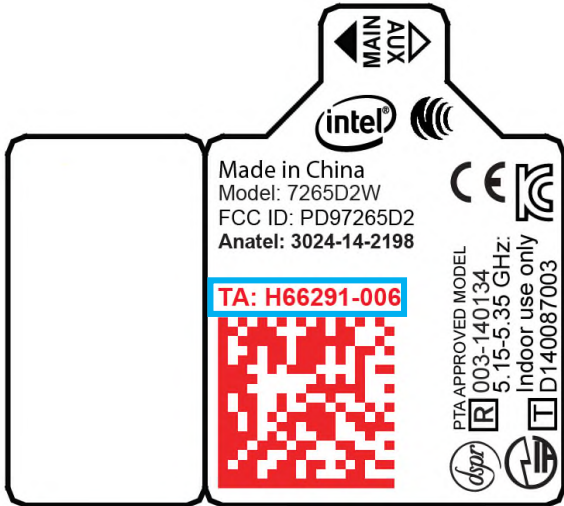
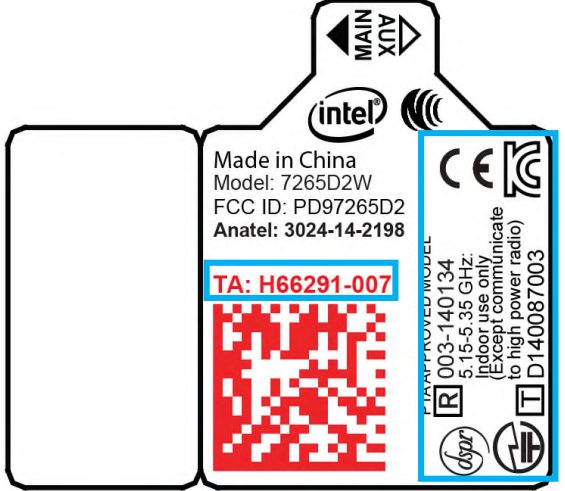
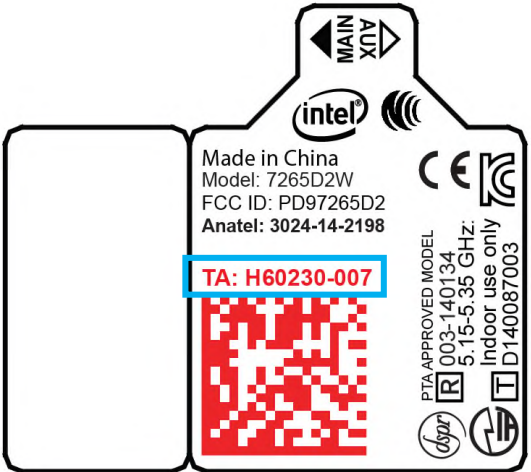
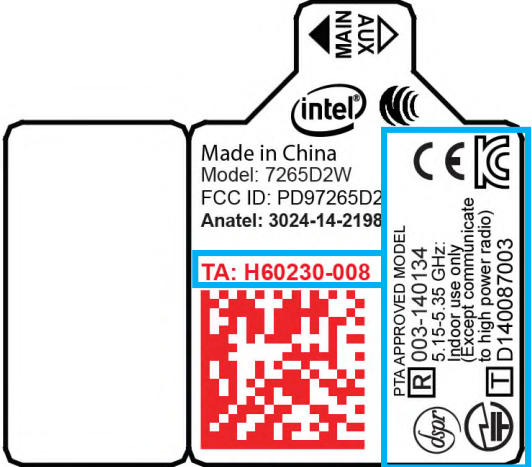
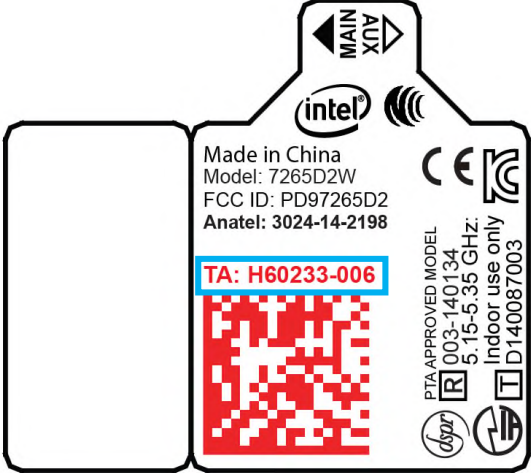
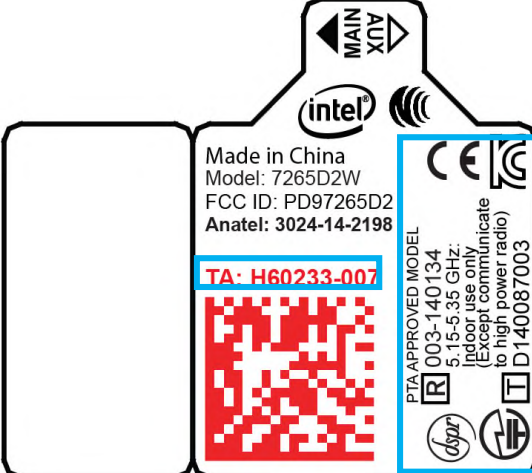
2. The Intel Tracking revision will be changed on the following products

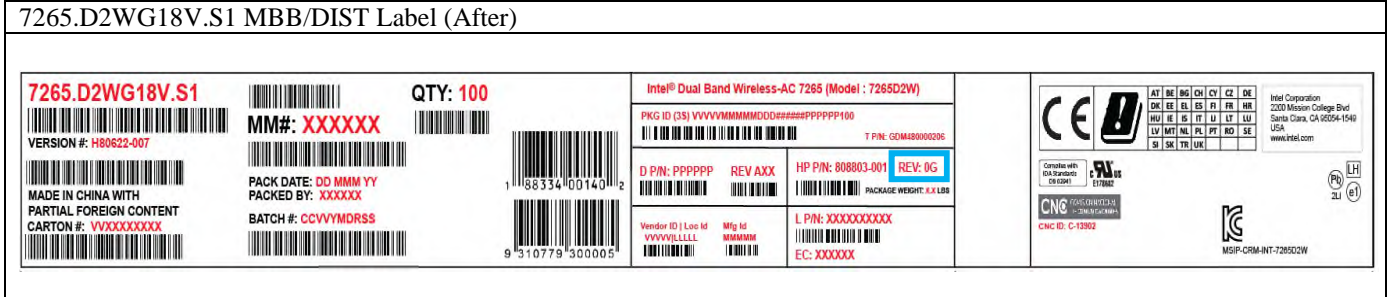
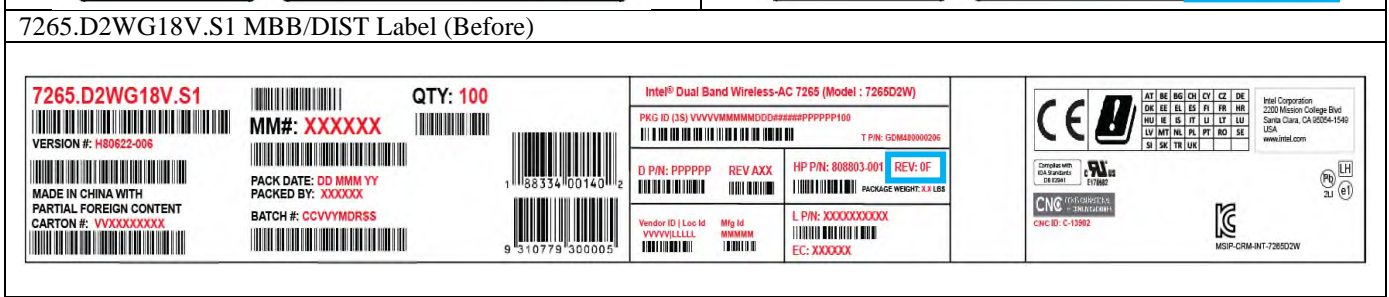
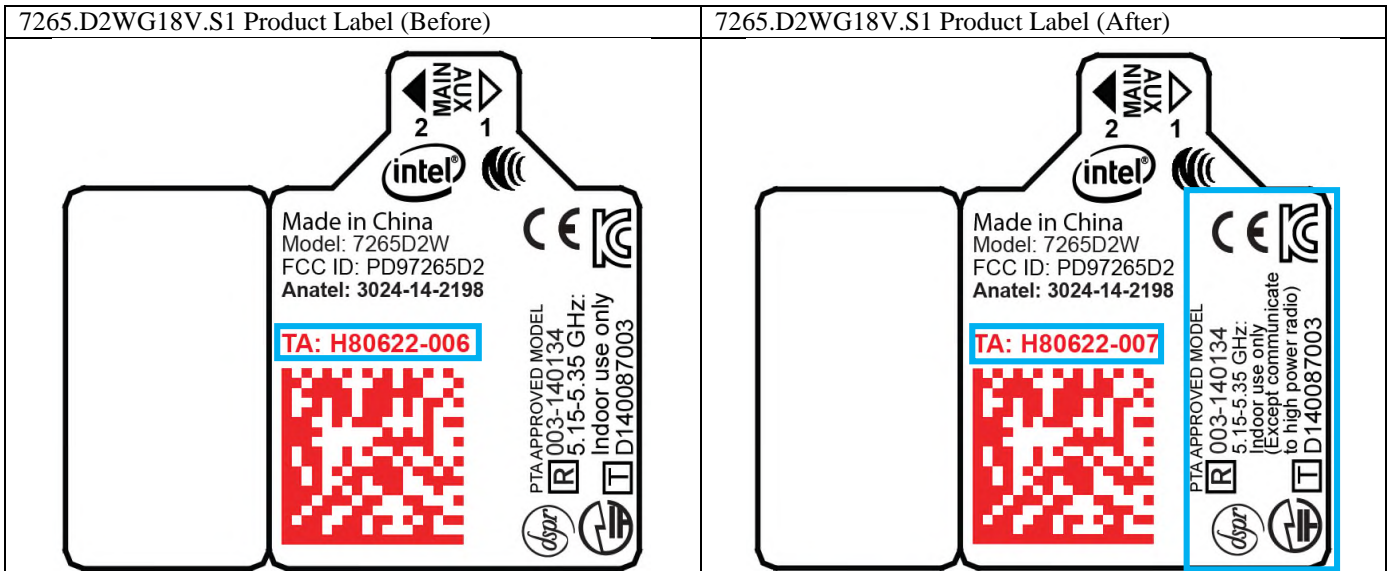
SKU	Before	After
7265.D2WG.W	0D	0E
7265.D2WG18V.S1	0F	0G
3165.D2WG	0E	0F

Label Images:

3165.D2WG Product Label (Before)	3165.D2WG Product Label (After)																
<p>Made in China Model: 3165D2W FCC ID: PD93165D2 Anatel: 3024-14-2198</p> <p>TA: H83890-008</p> <p>PTA APPROVED MODEL R 003-150155 5.15-5.35 GHz Indoor use only D150112003</p>	<p>Made in China Model: 3165D2W FCC ID: PD93165D2 Anatel: 3024-14-2198</p> <p>TA: H83890-009</p> <p>PTA APPROVED MODEL R 003-150155 5.15-5.35 GHz Indoor use only D150112003</p>																
3165.D2WG MBB/DIST Label (Before)	3165.D2WG MBB/DIST Label (After)																
<table border="1"> <tr> <td> 3165.D2WG VERSION #: H83890-008 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX </td> <td> QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVMYDRSS </td> <td> 88334 00140 9 310779 300005 </td> <td> Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W) PKG ID (3S) VVVVMMMMDD00####PPPPPP100 T P/N: G1TTTTTTTTT </td> <td> D P/N: P1PPPP REV AXX Vendor ID Loc Id VVVVLLLLL MMYMM </td> <td> HP P/N: 843530-001 REV: 0E PACKAGE WEIGHT: X.X LBS </td> <td> L P/N: XXXXXXXXXX EC: XXXXXXXX </td> <td> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1649 USA www.intel.com</p> <p>CCAH15LP1320T9 C-15841 C-16802 C-16865</p> <p>MSP-CRM-INT-7265D2W</p> </td> </tr> </table>	3165.D2WG VERSION #: H83890-008 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX	QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVMYDRSS	88334 00140 9 310779 300005	Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W) PKG ID (3S) VVVVMMMMDD00####PPPPPP100 T P/N: G1TTTTTTTTT	D P/N: P1PPPP REV AXX Vendor ID Loc Id VVVVLLLLL MMYMM	HP P/N: 843530-001 REV: 0E PACKAGE WEIGHT: X.X LBS	L P/N: XXXXXXXXXX EC: XXXXXXXX	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1649 USA www.intel.com</p> <p>CCAH15LP1320T9 C-15841 C-16802 C-16865</p> <p>MSP-CRM-INT-7265D2W</p>	<table border="1"> <tr> <td> 3165.D2WG VERSION #: H83890-009 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX </td> <td> QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVMYDRSS </td> <td> 88334 00140 9 310779 300005 </td> <td> Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W) PKG ID (3S) VVVVMMMMDD00####PPPPPP100 T P/N: G1TTTTTTTTT </td> <td> D P/N: P1PPPP REV AXX Vendor ID Loc Id VVVVLLLLL MMYMM </td> <td> HP P/N: 843530-001 REV: 0F PACKAGE WEIGHT: X.X LBS </td> <td> L P/N: XXXXXXXXXX EC: XXXXXXXX </td> <td> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1649 USA www.intel.com</p> <p>CCAH15LP1320T9 C-15841 C-16802 C-16865</p> <p>MSP-CRM-INT-7265D2W</p> </td> </tr> </table>	3165.D2WG VERSION #: H83890-009 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX	QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVMYDRSS	88334 00140 9 310779 300005	Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W) PKG ID (3S) VVVVMMMMDD00####PPPPPP100 T P/N: G1TTTTTTTTT	D P/N: P1PPPP REV AXX Vendor ID Loc Id VVVVLLLLL MMYMM	HP P/N: 843530-001 REV: 0F PACKAGE WEIGHT: X.X LBS	L P/N: XXXXXXXXXX EC: XXXXXXXX	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1649 USA www.intel.com</p> <p>CCAH15LP1320T9 C-15841 C-16802 C-16865</p> <p>MSP-CRM-INT-7265D2W</p>
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<p>3165.D2WG.S Product Label (Before)</p> <p>Made in China Model: 3165D2W FCC ID: PD93165D2 Anatel: 3024-14-2198</p> <p>TA: H85667-007</p> <p>PTA APPROVED MODEL R 003-150155 5.15-5.35 GHz: Indoor use only D150112003</p> <p>intel® MAIN XUV dspr CE</p>	<p>3165.D2WG.S Product Label (After)</p> <p>Made in China Model: 3165D2W FCC ID: PD93165D2 Anatel: 3024-14-2198</p> <p>TA: H85667-008</p> <p>PTA APPROVED MODEL R 003-150155 5.15-5.35 GHz: Indoor use only (Except communicate to high power radio) D150112003</p> <p>intel® MAIN XUV dspr CE</p>
<p>3165.D2WG18V Product Label (Before)</p> <p>Made in China Model: 3165D2W FCC ID: PD93165D2 Anatel: 3024-14-2198</p> <p>TA: H83892-007</p> <p>PTA APPROVED MODEL R 003-150155 5.15-5.35 GHz: Indoor use only D150112003</p> <p>intel® MAIN XUV dspr CE</p>	<p>3165.D2WG18V Product Label (After)</p> <p>Made in China Model: 3165D2W FCC ID: PD93165D2 Anatel: 3024-14-2198</p> <p>TA: H83892-008</p> <p>PTA APPROVED MODEL R 003-150155 5.15-5.35 GHz: Indoor use only (Except communicate to high power radio) D150112003</p> <p>intel® MAIN XUV dspr CE</p>

<p>7265.D2WG.S Product Label (Before)</p>  <p>Made in China Model: 7265D2W FCC ID: PD97265D2 Anatel: 3024-14-2198</p> <p>TA: H66291-006</p> <p>PTA APPROVED MODEL R 003-140134 5.15-5.35 GHz: Indoor use only D140087003</p> <p>intel dspr CE K</p>	<p>7265.D2WG.S Product Label (After)</p>  <p>Made in China Model: 7265D2W FCC ID: PD97265D2 Anatel: 3024-14-2198</p> <p>TA: H66291-007</p> <p>PTA APPROVED MODEL R 003-140134 5.15-5.35 GHz: Indoor use only (Except communicate to high power radio) D140087003</p> <p>intel dspr CE K</p>
<p>7265.D2WG18V Product Label (Before)</p>  <p>Made in China Model: 7265D2W FCC ID: PD97265D2 Anatel: 3024-14-2198</p> <p>TA: H60230-007</p> <p>PTA APPROVED MODEL R 003-140134 5.15-5.35 GHz: Indoor use only D140087003</p> <p>intel dspr CE K</p>	<p>7265.D2WG18V Product Label (After)</p>  <p>Made in China Model: 7265D2W FCC ID: PD97265D2 Anatel: 3024-14-2198</p> <p>TA: H60230-008</p> <p>PTA APPROVED MODEL R 003-140134 5.15-5.35 GHz: Indoor use only (Except communicate to high power radio) D140087003</p> <p>intel dspr CE K</p>
<p>7265.D2WG18V.S Product Label (Before)</p>  <p>Made in China Model: 7265D2W FCC ID: PD97265D2 Anatel: 3024-14-2198</p> <p>TA: H60233-006</p> <p>PTA APPROVED MODEL R 003-140134 5.15-5.35 GHz: Indoor use only D140087003</p> <p>intel dspr CE K</p>	<p>7265.D2WG18V.S Product Label (After)</p>  <p>Made in China Model: 7265D2W FCC ID: PD97265D2 Anatel: 3024-14-2198</p> <p>TA: H60233-007</p> <p>PTA APPROVED MODEL R 003-140134 5.15-5.35 GHz: Indoor use only (Except communicate to high power radio) D140087003</p> <p>intel dspr CE K</p>



Customer Impact of Change and Recommended Action:

The label changes to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
7265.D2WG.W	939403	H59008-009	H59008-010
7265.D2WG18V.S1	941689	H80622-006	H80622-007
3165.D2WG	944381	H83890-008	H83890-009
7265.D2WG18V	934449	H60230-007	H60230-008
7265.D2WG18V.S	934460	H60233-006	H60233-007
7265.D2WG.S	934470	H66291-006	H66291-007
7265.D2WG.I	936899	H92392-005	H92392-006
3165.D2WG18V	944382	H83892-007	H83892-008
3165.D2WG.S	944397	H85667-007	H85667-008
7265.D2WG.NVB	944431	H85435-008	H85435-009

PCN Revision History:

Date of Revision:

March 21, 2019

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

116850 - 00

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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apagccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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